

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT PTO-1449</b>	<b>DOCKET NO.</b> 10191/3939	<b>10/520886</b> To be assigned
	<b>APPLICANT</b> Andrea URBAN et al.	
	<b>FILING DATE</b> To be assigned	<b>GROUP</b> To be assigned

U. S. PATENT DOCUMENTS

EXAMINER INITIAL	PATENT/PUBLICATION NUMBER	PATENT/PUBLICATION DATE	NAME	CLASS	SUBCLASS	FILING DATE
<i>JS</i>	* 4,576,834	March 18, 1986	SOBCZAK, Z. P.			
<i>JS</i>	* 5,116,460	May 26, 1992	BUKHMANN, Y.			

- \* Copy of reference is not enclosed because reference is cited and described in Search Report (copy of reference provided by the International Searching Authority).

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						Yes	No
<i>JS</i>	199 19 469	November 2, 2000	DE			X*	
<i>JS</i>	42 41 045	June 16, 1994	DE			X**	
<i>JS</i>	44 20 962	December 21, 1995	DE			X**	
<i>JS</i>	198 47 455	April 27, 2000	DE			X**	
<i>JS</i>	197 06 682	August 27, 1998	DE			X**	
<i>JS</i>	199 00 179	February 24, 2000	DE			X**	

- \* Copy of reference is not enclosed because reference is cited and described in Search Report (copy of reference provided by the International Searching Authority).
- \*\* Mentioned in Specification.

OTHER DOCUMENTS

EXAMINER INITIAL	AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.
<i>JS</i>	* Ohara, J; Kano, K.; Takeuchi, Y.; Ohya, N.; Otsuka, Y.; Akita, S.: "A new deep reactive ion etching process by dual sidewall protection," Proceeding IEEE Thirteenth Annual International Conference On Micro Electro Mechanical Systems, Miyazaki, Japan, 23 - 27 January 2000, pp. 277-282.

- \* Copy of reference is not enclosed because reference is cited and described in Search Report (copy of reference provided by the International Searching Authority).

<b>EXAMINER</b> <i>Wesley Schul</i>	<b>DATE CONSIDERED</b> <i>12/18/07</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	